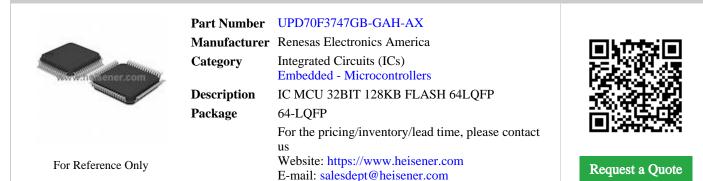


UPD70F3747GB-GAH-AX

UPD70F3747GB-GAH-AX Information



Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



UPD70F3747GB-GAH-AX Specifications

Manufacturer Part Number	UPD70F3747GB-GAH-AX
Manufacturer	Renesas Electronics America
Category	Integrated Circuits (ICs)
	Embedded - Microcontrollers
Package	64-LQFP
Series	V850ES/Hx3
Core Processor	V850ES
Core Size	32-Bit
Speed	32MHz
Connectivity	CSI, I2C, UART/USART
Peripherals	DMA, LVD, PWM, WDT
Number of I/O	51
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	3.7 V ~ 5.5 V
Data Converters	A/D 10x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	-
Package / Case	64-LQFP
Supplier Device Package	-
	Report errors?

UPD70F3747GB-GAH-AX Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

UPD70F3747GB-GAH-AX Payment Methods



If you have any question about UPD70F3747GB-GAH-AX, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com